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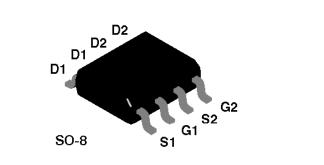
NDS9936 Dual N-Channel Enhancement Mode Field Effect Transistor

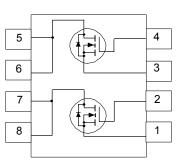
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as DC/DC conversion, disk drive motor control, and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- 5A, 30V. $R_{DS(ON)} = 0.05\Omega @ V_{GS} = 10V.$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.





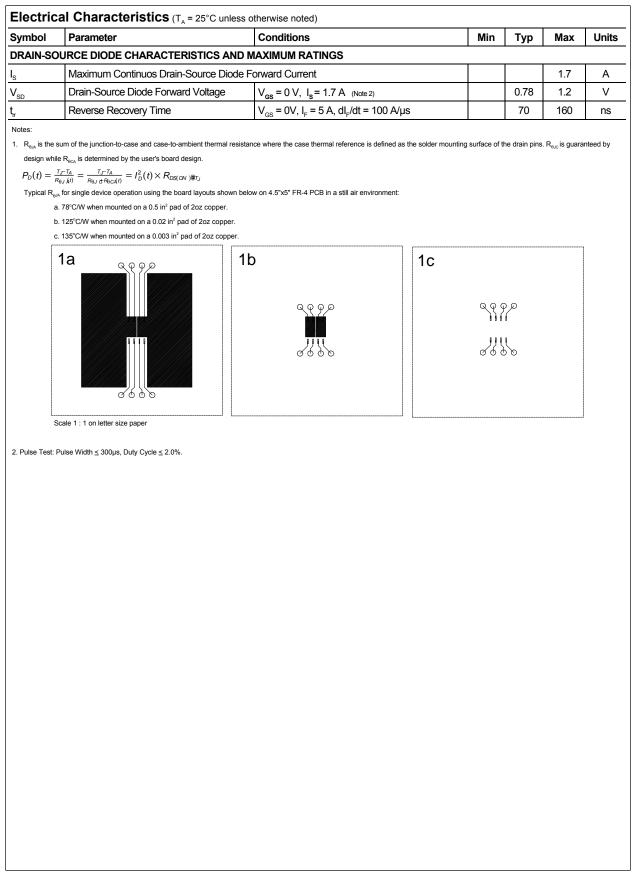
Absolute Maximum Ratings $T_{A} = 25^{\circ}C$ unless otherwise noted

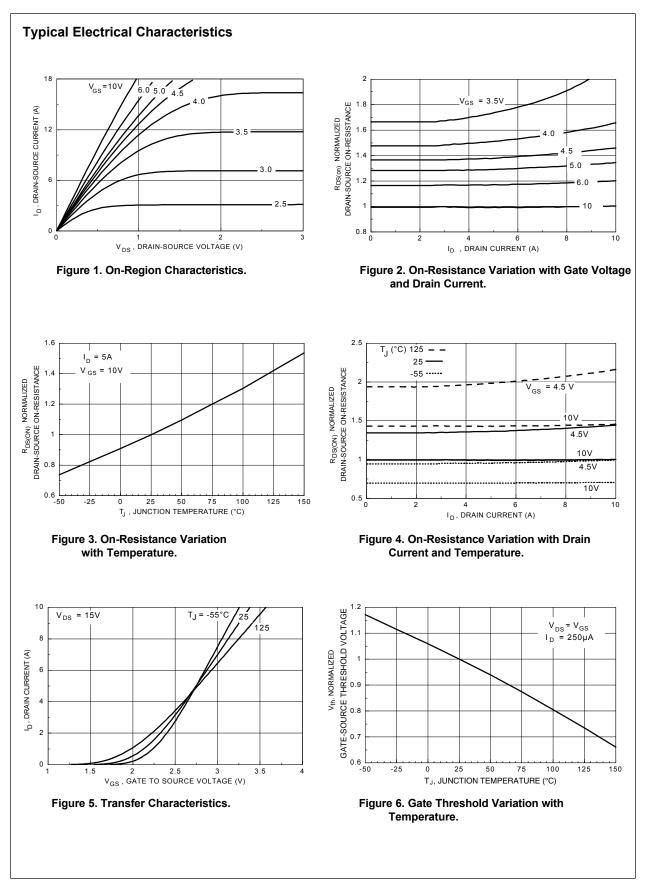
| Symbol | Parameter | | NDS9936 | Units |
|----------------------------------|--|-----------|------------|-------|
| V _{DSS} | Drain-Source Voltage | | 30 | V |
| V _{GSS} | Gate-Source Voltage | | ± 20 | V |
| l _D | Drain Current - Continuous @ $T_A = 25^{\circ}C$ | (Note 1a) | ± 5.0 | A |
| | - Continuous @ T _A = 70°C | (Note 1a) | ± 4.0 | |
| | - Pulsed ($T_A = 25^{\circ}C$ | | ± 40 | |
| P _D | Power Dissipation for Dual Operation | | 2 | W |
| | Power Dissipation for Single Operation | (Note 1a) | 1.6 | |
| | | (Note 1b) | 1 | |
| | | (Note 1c) | 0.9 | |
| Γ _J ,T _{stg} | Operating and Storage Temperature Range | | -55 to 150 | °C |
| THERMA | L CHARACTERISTICS | | | |
| ۲ _{өја} | Thermal Resistance, Junction-to-Ambient | (Note 1a) | 78 | °C/W |
| Reac | Thermal Resistance, Junction-to-Case | (Note 1) | 40 | °C/W |

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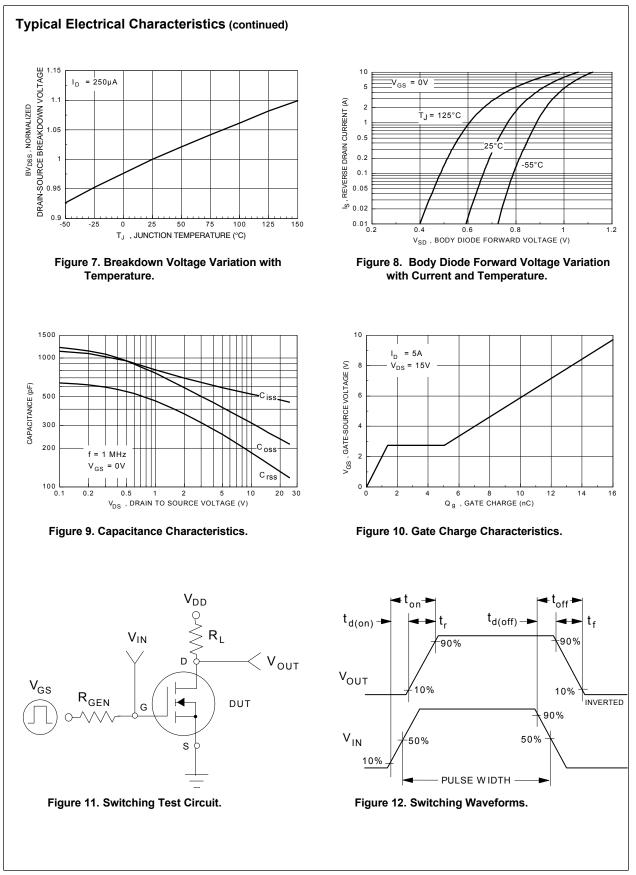
February 1996

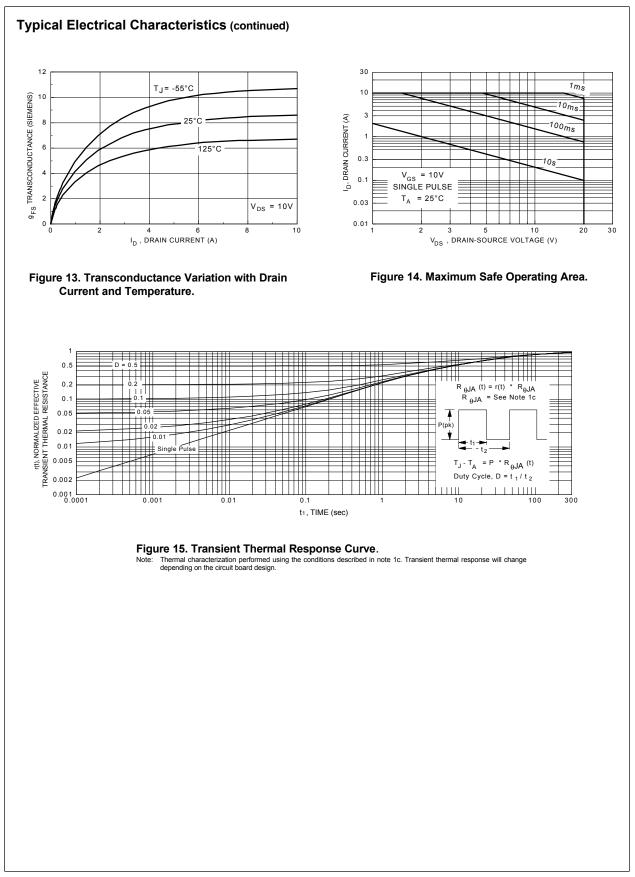
| Symbol | Parameter | Conditions | | Min | Тур | Max | Units |
|---------------------|-----------------------------------|---|-----------------------|-----|-------|------|-------|
| OFF CHA | RACTERISTICS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{gs} = 0 V, I _p = 250 μA | | 30 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 24 V, V _{GS} = 0 V | | | | 2 | μA |
| | | | T_= 55°C | | | 20 | μA |
| I _{GSSF} | Gate - Body Leakage, Forward | V _{GS} = 20 V, V _{DS} = 0 V | | | | 100 | nA |
| I _{GSSR} | Gate - Body Leakage, Reverse | V _{gs} = -20 V, V _{ps} = 0 V | | | | -100 | nA |
| ON CHAR | ACTERISTICS (Note 2) | | | | | | |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ | | 1 | 1.4 | 3 | V |
| | | | T_=125°C | 0.7 | 1.1 | 2.2 | 1 |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{gs} = 10 V, I _p = 5 A | | | 0.044 | 0.05 | Ω |
| | | | T_=125°C | | 0.066 | 0.1 | 1 |
| | | V _{gs} = 4.5 V, I _p = 3.9 A | | | 0.066 | 0.08 | 1 |
| | | | T _J =125°C | | 0.099 | 0.16 | 1 |
| I _{D(on)} | On-State Drain Current | V _{GS} = 10 V, V _{DS} = 10 V | = 10 V | | | | Α |
| | | V_{GS} = 4.5 V, V_{DS} = 10 V | | 20 | | |] |
| g _{FS} | Forward Transconductance | V _{DS} = 10 V, I _D = 3.5 A | | 3 | 8 | | S |
| DYNAMIC | CHARACTERISTICS | | | | | | |
| C _{iss} | Input Capacitance | $V_{ps} = 15 V, V_{qs} = 0 V,$ f = 1.0 MHz | | | 525 | | pF |
| C _{oss} | Output Capacitance | | | | 315 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | | 185 | | pF |
| SWITCHI | NG CHARACTERISTICS (Note 2) | | | | | | |
| t _{D(ON)} | Tum - On Delay Time | $V_{DD} = 15 V, I_{D} = 1 A,$ | | | 12 | 30 | ns |
| t, | Turn - On Rise Time | V_{GS} = 10 V, R_{GEN} = 6 Ω | | | 10 | 25 | ns |
| t _{D(OFF)} | Turn - Off Delay Time | | | | 25 | 50 | ns |
| t _r | Turn - Off Fall Time | | | | 10 | 50 | ns |
| Q _g | Total Gate Charge | V _{DS} = 15 V, | | | 17 | 35 | nC |
| Q _{gs} | Gate-Source Charge | $I_{\rm D} = 5 \text{A}, V_{\rm GS} = 10 \text{V}$ | | | 1.5 | | nC |
| Q_{gd} | Gate-Drain Charge | | | | 3.7 | | nC |





NDS9936.SAM





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